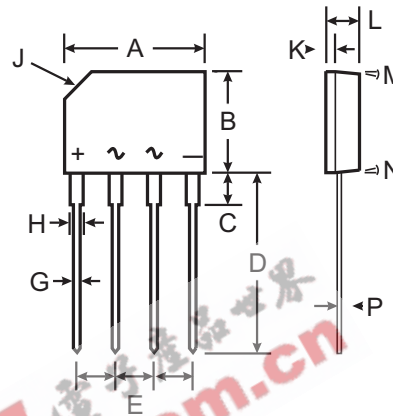


Features

- Glass Passivated Die Construction
- High Case Dielectric Strength of 1500V_{RMS}
- Low Reverse Leakage Current
- Surge Overload Rating to 40A Peak
- Ideal for Printed Circuit Board Applications
- UL Listed Under Recognized Component Index, File Number E94661
- **Lead Free Finish, RoHS Compliant (Note 2)**

Mechanical Data

- Case: KBP
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Terminals: Finish – Matte Tin. Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Marking: Type Number
- Mounting Position: Any
- Approx. Weight: 1.52 grams



| KBP | | |
|----------------------|-------------------|-------|
| Dim | Min | Max |
| A | 14.25 | 14.75 |
| B | 10.20 | 10.60 |
| C | 2.29 Typical | |
| D | 14.25 | 14.73 |
| E | 3.56 | 4.06 |
| G | 0.76 | 0.86 |
| H | 1.17 | 1.42 |
| J | 2.8 X 45° Chamfer | |
| K | 0.80 | 1.10 |
| L | 3.35 | 3.65 |
| M | 3° Nominal | |
| N | 2° Nominal | |
| P | 0.30 | 0.64 |
| All Dimensions in mm | | |

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

| Characteristic | Symbol | KBP 005G | KBP 01G | KBP 02G | KBP 04G | KBP 06G | KBP 08G | KBP 10G | Unit |
|---|--|-------------|---------|---------|---------|---------|---------|---------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Output Current @ T _C = 105°C | I _O | 1.5 | | | | | | | A |
| Non-Repetitive Peak Forward Surge Current, 8.3 ms single half-sine-wave superimposed on rated load (JEDEC method) | I _{FSM} | 40 | | | | | | | A |
| Forward Voltage per element @ I _F = 1.5A | V _{FM} | 1.1 | | | | | | | V |
| Peak Reverse Current @ T _C = 25°C at Rated DC Blocking Voltage @ T _C = 125°C | I _{RM} | 5.0 500 | | | | | | | μA |
| Typical Total Capacitance per (Note 1) | C _T | 20 | | | | | | | pF |
| Typical Thermal Resistance, junction to case | R _{θJC} | 18 | | | | | | | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | | | | | | | °C |

- Notes:
1. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.
 2. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see *EU Directive Annex Notes 5 and 7*.
 3. Unit mounted on 300 x 300 x 1.6mm aluminum plate heat sink.

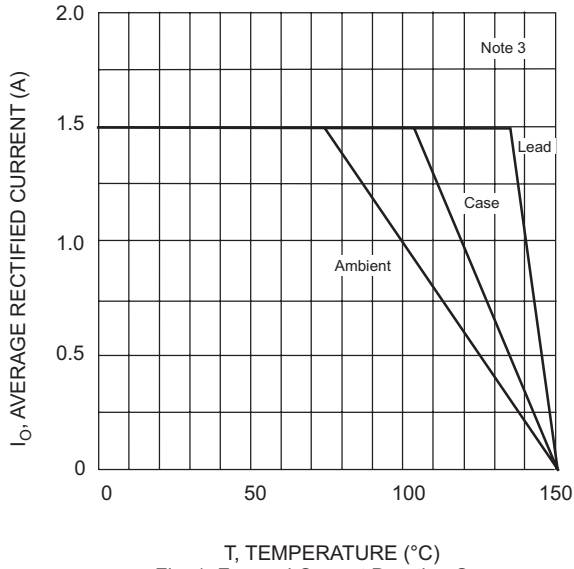


Fig. 1 Forward Current Derating Curve

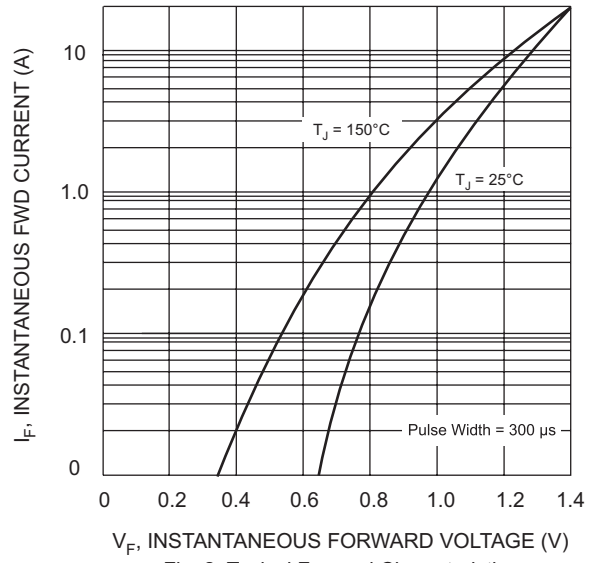


Fig. 2 Typical Forward Characteristics

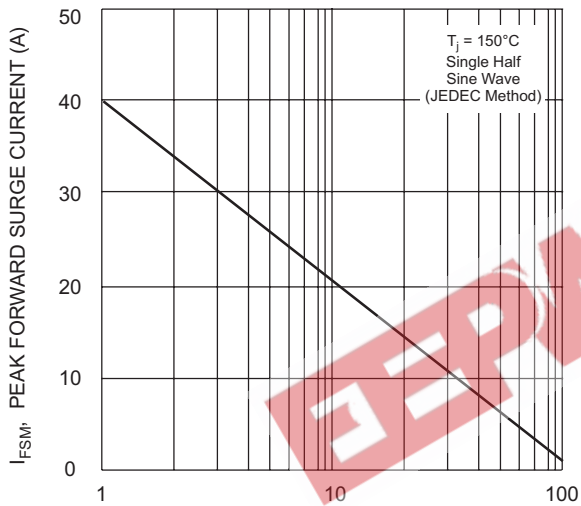


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

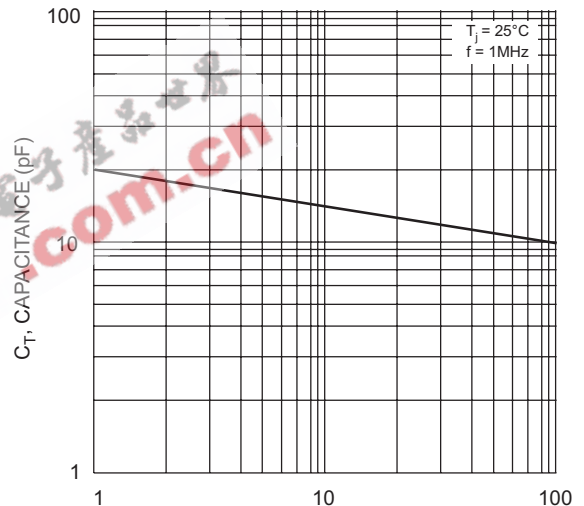


Fig. 4 Typical Total Capacitance

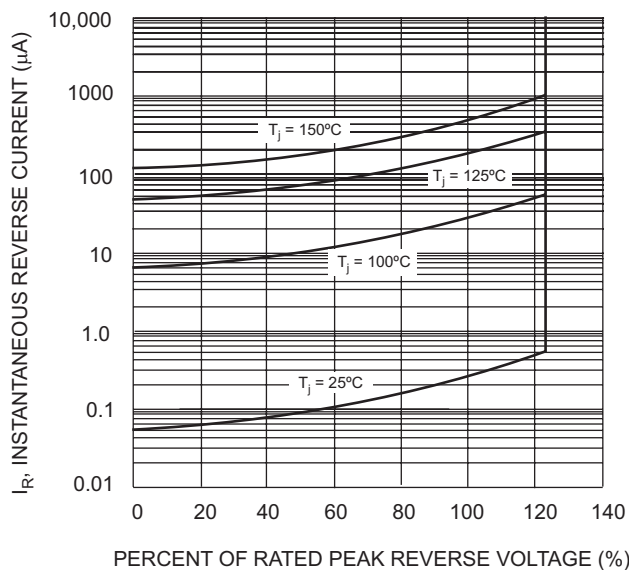


Fig. 5 Typical Reverse Characteristics

Ordering Information (Note 4)

| Device | Packaging | Shipping |
|-----------|-----------|--------------------|
| KBP005G-7 | KBP | 35 pieces per Tube |
| KBP01G-7 | KBP | 35 pieces per Tube |
| KBP02G-7 | KBP | 35 pieces per Tube |
| KBP04G-7 | KBP | 35 pieces per Tube |
| KBP06G-7 | KBP | 35 pieces per Tube |
| KBP08G-7 | KBP | 35 pieces per Tube |
| KBP10G-7 | KBP | 35 pieces per Tube |

Notes: 4. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.